



SPN9910

N-Channel Enhancement Mode MOSFET

DESCRIPTION

The SPN9910 is the N-Channel logic enhancement mode power field effect transistors are produced using high cell density, DMOS trench technology. This high density process is especially tailored to minimize on-state resistance. These devices are particularly suited for most of synchronous buck converter applications.

APPLICATIONS

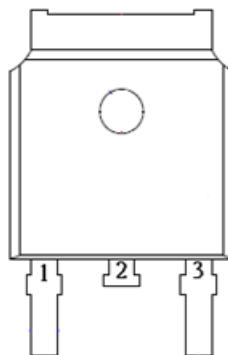
- DC/DC Converter
- Load Switch
- Synchronous Buck Converter

FEATURES

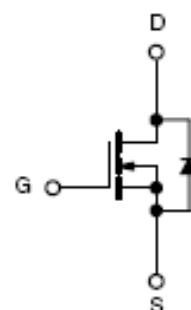
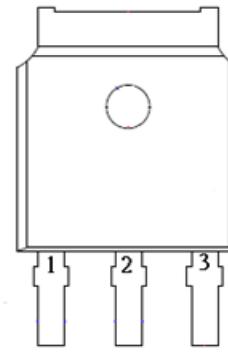
- ◆ 60V/60A, $R_{DS(ON)}=10m\Omega$ @ $V_{GS}=10V$
- ◆ 60V/60A, $R_{DS(ON)}=12.0m\Omega$ @ $V_{GS}=4.5V$
- ◆ Super high density cell design for extremely low $R_{DS(ON)}$
- ◆ Exceptional on-resistance and maximum DC current capability
- ◆ TO-252-2L/TO-251S-3L package design

PIN CONFIGURATION

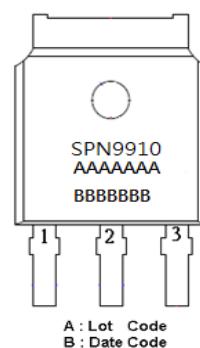
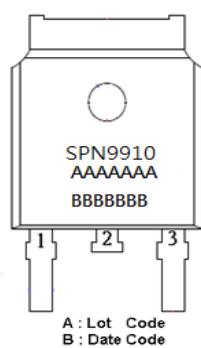
TO-252



TO-251



PART MARKING





SPN9910

N-Channel Enhancement Mode MOSFET

PIN DESCRIPTION

Pin	Symbol	Description
1	G	Gate
2	D	Drain
3	S	Source

ORDERING INFORMATION

Part Number	Package	Part Marking
SPN9910T252RGB	TO-252-2L	SPN9910
SPN9910ST251TGB	TO-251S-3L	SPN9910

※ SPN9910T252RGB: Tape Reel ; Pb – Free; Halogen – Free

※ SPN9910ST251TGB: Tube ; Pb – Free; Halogen – Free

ABSOULTE MAXIMUM RATINGS

(TA=25°C Unless otherwise noted)

Parameter	Symbol	Typical	Unit
Drain-Source Voltage	V _{DSS}	60	V
Gate –Source Voltage	V _{GSS}	±20	V
Continuous Drain Current(T _J =150°C)	T _A =25°C	ID	A
	T _A =100°C		
Pulsed Drain Current	I _{DM}	120	A
Avalanche Current	I _{AS}	38	A
Power Dissipation	T _A =25°C	P _D	W
Avalanche Energy with Single Pulse (T _j =25°C , L = 0.1mH , I _{AS} = 38A , V _{DD} = 25V.)	EAS	123	mJ
Operating Junction Temperature	T _J	-55/150	°C
Storage Temperature Range	T _{STG}	-55/150	°C
Thermal Resistance-Junction to Ambient	R _{θJA}	62	°C/W



SPN9910

N-Channel Enhancement Mode MOSFET

ELECTRICAL CHARACTERISTICS

(TA=25°C Unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} =0V, I _D =250uA	60			V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250uA	1.0		2.5	
Gate Leakage Current	I _{GSS}	V _{DS} =0V, V _{GS} =±20V			±100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =48V, V _{GS} =0V			1	uA
		V _{DS} =48V, V _{GS} =0V T _J =55°C			5	
On-State Drain Current	I _{D(on)}	V _{DS} ≥5V, V _{GS} =10V	60			A
Drain-Source On-Resistance	R _{D(on)}	V _{GS} =10V, I _D =15A		10	12	mΩ
		V _{GS} =4.5V, I _D =10A		12	15	
Forward Transconductance	g _{fs}	V _{DS} =5V, I _D =15A		47		S
Diode Forward Voltage	V _{SD}	I _S =60A, V _{GS} =0V			1.2	V
Dynamic						
Total Gate Charge	Q _g	V _{DS} =48V, V _{GS} =4.5V I _D =12A		24		nC
Gate-Source Charge	Q _{gs}			6.9		
Gate-Drain Charge	Q _{gd}			10		
Input Capacitance	C _{iss}	V _{DS} =15V, V _{GS} =0V f=1MHz		3200		pF
Output Capacitance	C _{oss}			210		
Reverse Transfer Capacitance	C _{rss}			145		
Turn-On Time	t _{d(on)}	V _{DD} =30V, I _D =2A, V _{GEN} =10V, R _G =3.3Ω		20		nS
	t _r			4		
Turn-Off Time	t _{d(off)}			84.5		
	t _f			6.5		



SPN9910 N-Channel Enhancement Mode MOSFET

TYPICAL CHARACTERISTICS

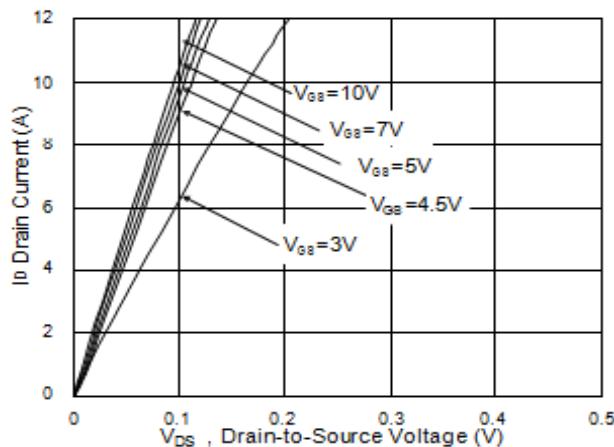


Fig. 1 Typical Output Characteristics

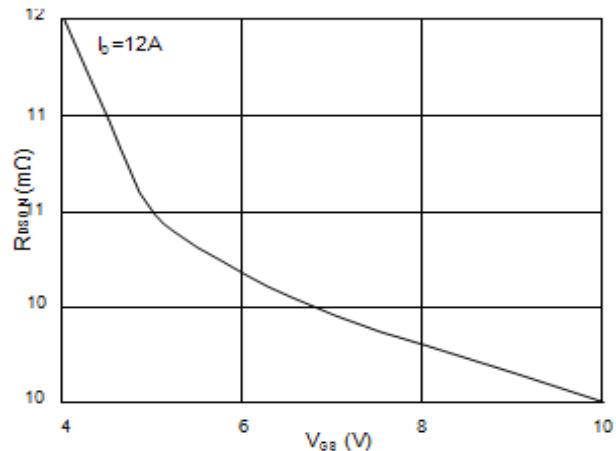


Fig. 2 On-Resistance vs. Gate Voltage

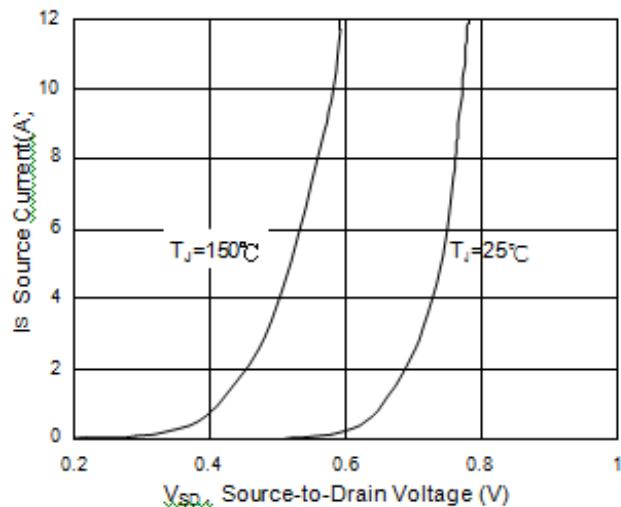


Fig. 3 Forward Characteristics
Reverse Diodes

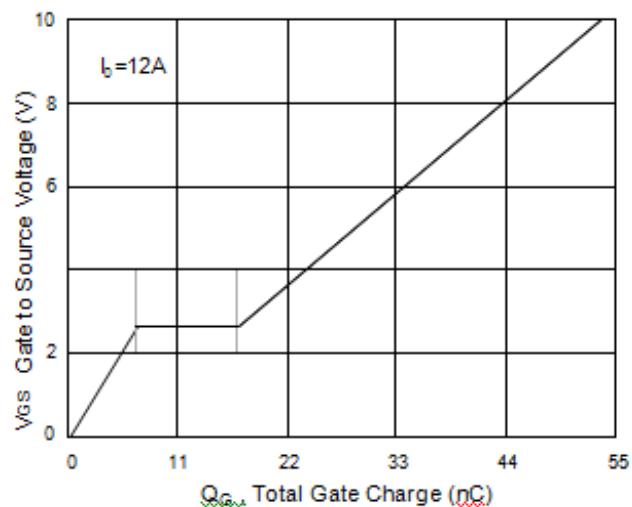


Fig. 4 Gate Charge Characteristics

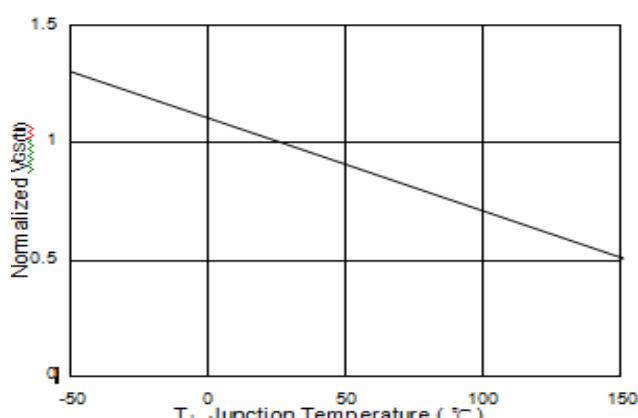


Fig. 5 V_{GS} vs. Junction Temperature

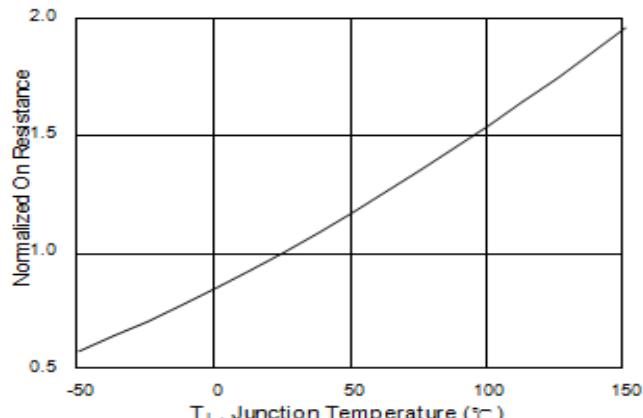


Fig. 6 On-Resistance vs. Temperature



SPN9910

N-Channel Enhancement Mode MOSFET

TYPICAL CHARACTERISTICS

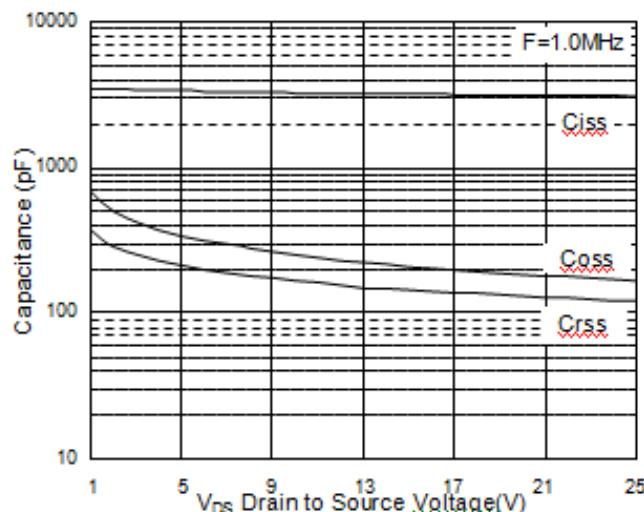


Fig. 7 Typical Capacitance Characteristics

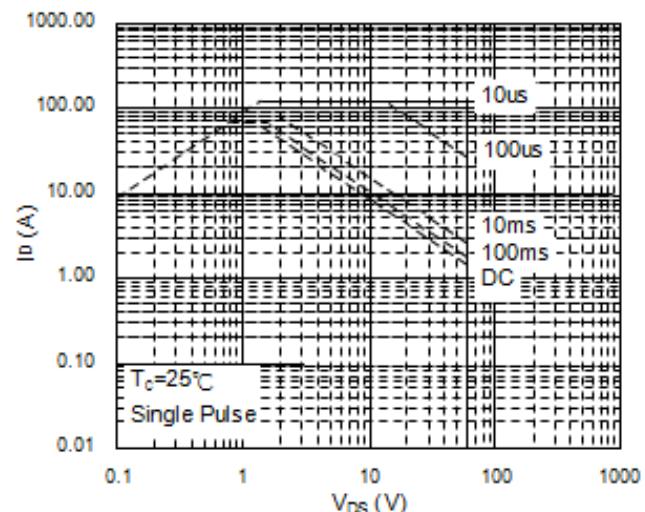


Fig. 8 Maximum Safe Operation Area

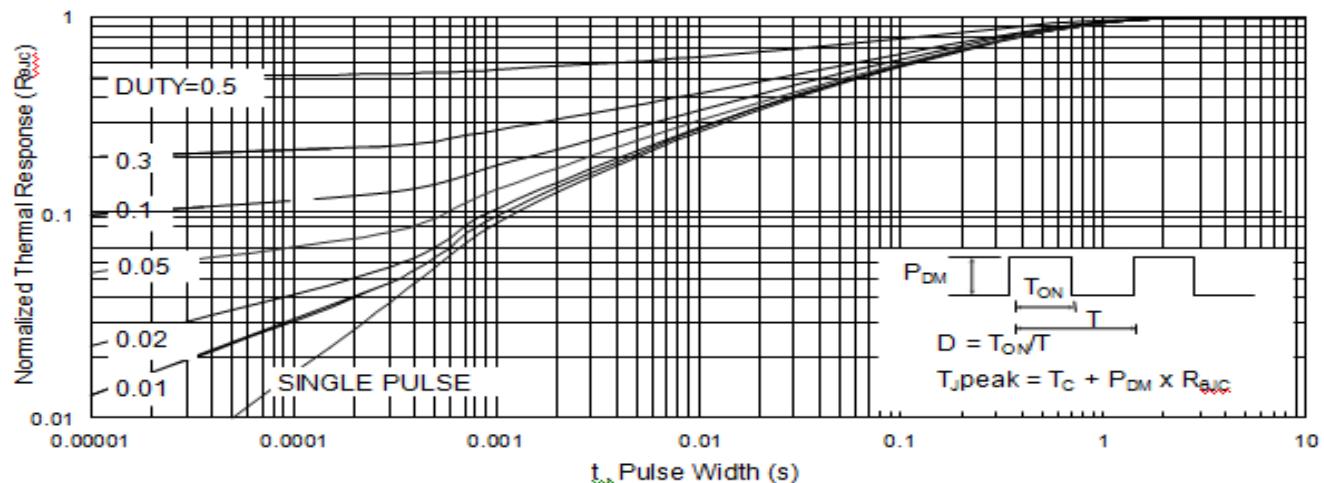


Fig. 9 Effective Transient Thermal Impedance

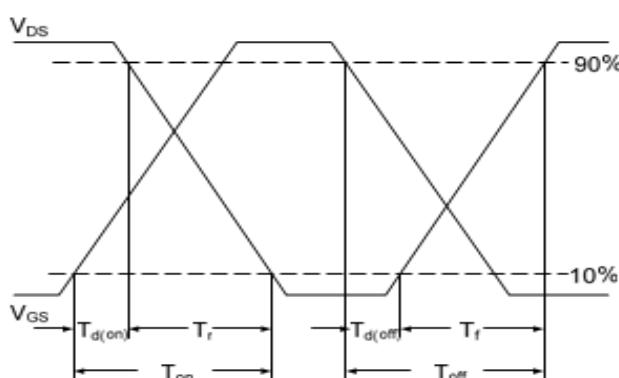


Fig. 10 Switching Time Waveform

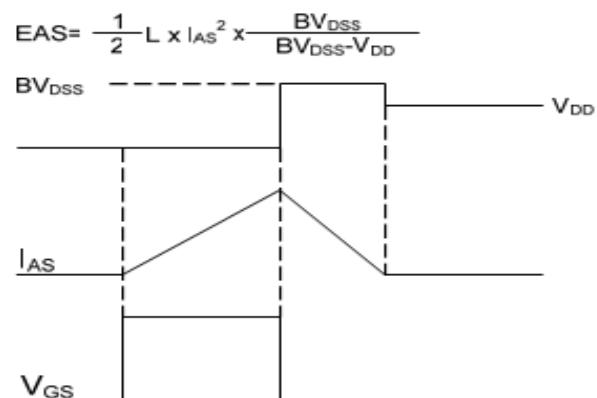


Fig. 11 Unclamped Inductive Waveform



SPN9910

N-Channel Enhancement Mode MOSFET

Information provided is alleged to be exact and consistent. SYNC Power Corporation presumes no responsibility for the penalties of use of such information or for any violation of patents or other rights of third parties which may result from its use. No license is granted by allegation or otherwise under any patent or patent rights of SYNC Power Corporation. Conditions mentioned in this publication are subject to change without notice. This publication surpasses and replaces all information previously supplied. SYNC Power Corporation products are not authorized for use as critical components in life support devices or systems without express written approval of SYNC Power Corporation.

© The SYNC Power logo is a registered trademark of SYNC Power Corporation

© 2020 SYNC Power Corporation – Printed in Taiwan – All Rights Reserved

SYNC Power Corporation

7F-2, No.3-1 Park Street

NanKang District (NKSP), Taipei, Taiwan 115

Phone: 886-2-2655-8178

Fax: 886-2-2655-8468

© <http://www.syncpower.com>